

## CURRENT MODE PWM CONTROLLER (KNOWN GOOD DIE)

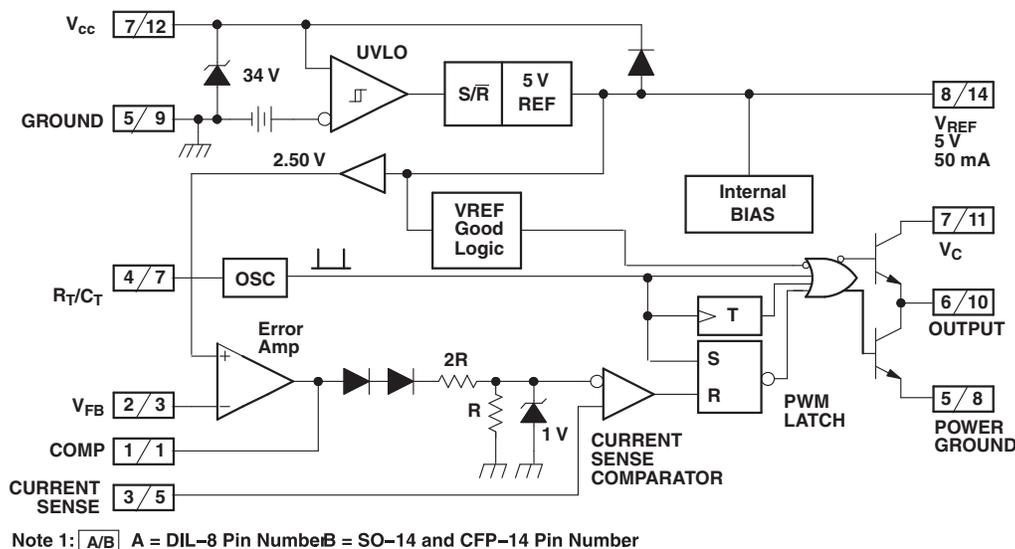
### FEATURES

- **–55°C to 125°C Known Good Die**
- **Controlled Baseline**
- **Optimized For Off-line and DC-to-DC Converters**
- **Low Start-Up Current (<1 mA)**
- **Automatic Feed Forward Compensation**
- **Pulse-by-Pulse Current Limiting**
- **Enhanced Load Response Characteristics**
- **Under-Voltage Lockout With Hysteresis**
- **Double Pulse Suppression**
- **High Current Totem Pole Output**
- **Internally Trimmed Bandgap Reference**
- **500-kHz Operation**
- **Low  $R_O$  Error Amp**

### DESCRIPTION

The UC1843 family of control devices provides the necessary features to implement off-line or dc-to-dc fixed frequency current mode control schemes with a minimal external parts count. Internally implemented circuits include under-voltage lockout featuring start up current less than 1 mA, a precision reference trimmed for accuracy at the error amp input, logic to insure latched operation, a PWM comparator which also provides current limit control, and a totem pole output stage designed to source or sink high peak current. The output stage, suitable for driving N-Channel MOSFETs, is low in the off state. The under-voltage lockout threshold is 8.4 V and maximum duty cycle range is around 100%.

### BLOCK DIAGRAM



### ORDERING INFORMATION<sup>(1)</sup>

| T <sub>A</sub> | PACKAGE <sup>(2)</sup> | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|------------------------|-----------------------|------------------|
| –55°C to 125°C | KGD                    | UC1843KGD1            | NA               |

(1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at [www.ti.com](http://www.ti.com).

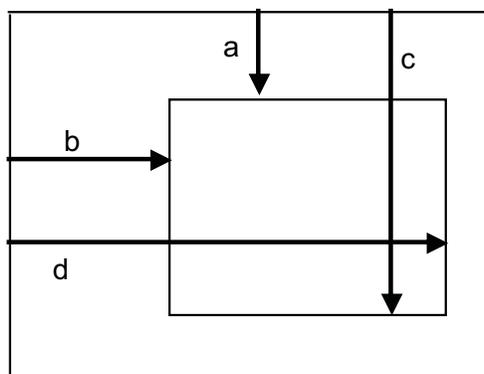
(2) Package drawings, thermal data, and symbolization are available at [www.ti.com/packaging](http://www.ti.com/packaging).



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

**BARE DIE INFORMATION**

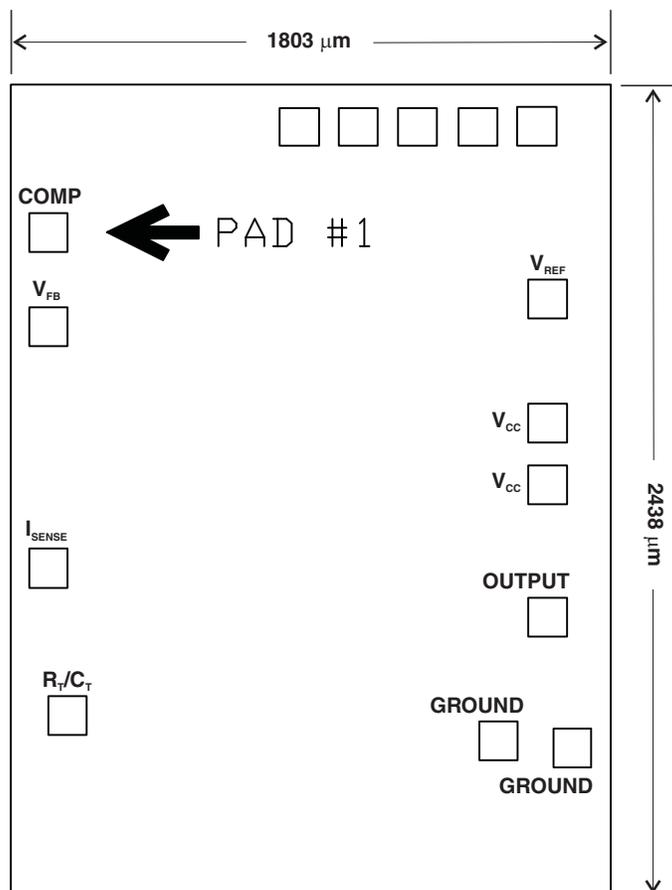
| DIE THICKNESS | BACKSIDE FINISH        | BACKSIDE POTENTIAL | BOND PAD METALLIZATION COMPOSITION |
|---------------|------------------------|--------------------|------------------------------------|
| 15 mils.      | Silicon with backgrind | GND                | Al-Si-Cu (0.5%)                    |



Origin

**BOND PAD COORDINATES (in Mils)**

| DESCRIPTION                    | PAD NUMBER | a     | b     | c     | d     |
|--------------------------------|------------|-------|-------|-------|-------|
| COMP                           | 1          | 78.70 | 63.40 | 82.90 | 67.60 |
| V <sub>FB</sub>                | 2          | 70.60 | 63.40 | 74.80 | 67.60 |
| I <sub>SENSE</sub>             | 3          | 39.40 | 63.40 | 43.60 | 67.60 |
| R <sub>T</sub> /C <sub>T</sub> | 4          | 18.60 | 61.20 | 22.60 | 65.60 |
| GROUND                         | 5          | 17.80 | 11.70 | 22.00 | 15.90 |
| GROUND                         | 6          | 17.40 | 3.90  | 21.80 | 8.10  |
| OUTPUT                         | 7          | 32.60 | 6.40  | 36.80 | 10.60 |
| V <sub>CC</sub>                | 8          | 47.50 | 6.40  | 51.70 | 10.60 |
| V <sub>CC</sub>                | 9          | 54.60 | 6.40  | 58.80 | 10.60 |
| V <sub>REF</sub>               | 10         | 68.70 | 6.40  | 72.90 | 10.60 |
| NC                             | TESTPAD    | 87.10 | 6.30  | 90.80 | 10.30 |
| NC                             | TESTPAD    | 87.10 | 12.60 | 90.80 | 16.60 |
| NC                             | TESTPAD    | 87.10 | 18.00 | 90.80 | 22.00 |
| NC                             | TESTPAD    | 87.10 | 24.30 | 90.80 | 28.30 |
| NC                             | TESTPAD    | 87.10 | 30.60 | 90.80 | 34.60 |



**ABSOLUTE MAXIMUM RATINGS**

|                                 |                          | <b>UNIT</b>       |
|---------------------------------|--------------------------|-------------------|
| Supply voltage                  | Low impedance source     | 30 V              |
|                                 | $I_{CC} < 30 \text{ mA}$ | Self Limiting     |
| Output current                  |                          | $\pm 1 \text{ A}$ |
| Output energy (capacitive load) |                          | 5 $\mu\text{J}$   |
| Analog inputs (Pins 2, 3)       |                          | -0.3 V to 6.3 V   |
| Error amp output sink current   |                          | 10 mA             |
| Storage temperature range       |                          | -65°C to 150°C    |
| Junction temperature range      |                          | -55°C to 150°C    |

## ELECTRICAL CHARACTERISTICS

Unless otherwise stated, these specifications apply for  $-55^{\circ}\text{C} \leq T_A \leq 125^{\circ}\text{C}$ ;  $V_{CC} = 15\text{ V}^{(1)}$ ;  $R_T = 10\text{ kW}$ ;  $C_T = 3.3\text{ nF}$ ,  $T_A = T_J$ .

| PARAMETER                    | TEST CONDITIONS  | MIN  | TYP  | MAX  | UNIT                   |
|------------------------------|--|------|------|------|------------------------|
| <b>REFERENCE SECTION</b>     |  |      |      |      |                        |
| Output Voltage               | $T_J = 25^{\circ}\text{C}$ , $I_O = 1\text{ mA}$                                     | 4.95 | 5.00 | 5.05 | V                      |
| Line Regulation              | $12 \leq V_{IN} \leq 25\text{ V}$  |      | 6    | 20   | mV                     |
| Load Regulation              | $1 \leq I_O \leq 20\text{ mA}$   |      | 6    | 25   |                        |
| Temperature Stability        | See <sup>(2)(3)</sup>  |      | 0.2  | 0.4  | mV/ $^{\circ}\text{C}$ |
| Total Output Variation       | Line, load, tempature <sup>(2)</sup>   | 4.9  |      | 5.1  | V                      |
| Output Noise Voltage         | $10\text{ Hz} \leq f \leq 10\text{ kHz}$ , $T_J = 25^{\circ}\text{C}$ <sup>(2)</sup> |      | 50   |      | $\mu\text{V}$          |
| Long Term Stability          | $T_A = 125^{\circ}\text{C}$ , 1000 Hrs <sup>(2)</sup>                                |      | 5    | 25   | mV                     |
| Output Short Circuit         |  | -30  | -100 | -180 | mA                     |
| <b>OSCILLATOR SECTION</b>    |  |      |      |      |                        |
| Initial Accuracy             | $T_J = 25^{\circ}\text{C}^{(4)}$   | 47   | 52   | 57   | kHz                    |
| Voltage Stability            | $12 \leq V_{CC} \leq 25\text{ V}$  |      | 0.2% | 1%   |                        |
| Temperature Stability        | $T_{MIN} \leq T_A \leq T_{MAX}$ <sup>(2)</sup>                                       |      | 5%   |      |                        |
| Amplitude                    | $V_{PIN\ 4}$ peak-to-peak <sup>(2)</sup>   |      | 1.7  |      | V                      |
| <b>ERROR AMP SECTION</b>     |  |      |      |      |                        |
| Input Voltage                | $V_{PIN\ 1} = 2.5\text{ V}$  | 2.45 | 2.50 | 2.55 | V                      |
| Input Bias Current           |  |      | -0.3 | -1   |                        |
| $A_{VOL}$                    | $2 \leq V_O \leq 4\text{ V}$   | 65   | 90   |      | dB                     |
| Unity Gain Bandwidth         | $T_J = 25^{\circ}\text{C}$ <sup>(2)</sup>  | 0.7  | 1    |      |                        |
| PSRR                         | $12 \leq V_{CC} \leq 25\text{ V}$  | 60   | 70   |      | dB                     |
| Output Sink Current          | $V_{PIN\ 2} = 2.7\text{ V}$ , $V_{PIN\ 1} = 1.1\text{ V}$                            | 2    | 6    |      |                        |
| Output Source Current        | $V_{PIN\ 2} = 2.3\text{ V}$ , $V_{PIN\ 1} = 5\text{ V}$                              | -0.5 | -0.8 |      | mA                     |
| $V_{OUT}$ High               | $V_{PIN\ 2} = 2.3\text{ V}$ , $R_L = 15\text{ k}\Omega$ to ground                    | 5    | 6    |      |                        |
| $V_{OUT}$ Low                | $V_{PIN\ 2} = 2.7\text{ V}$ , $R_L = 15\text{ k}\Omega$ to Pin 8                     |      | 0.7  | 1.1  | V                      |
|                              |  |      |      |      |                        |
| <b>CURRENT SENSE SECTION</b> |  |      |      |      |                        |
| Gain                         | See <sup>(5)(6)</sup>  | 2.85 | 3    | 3.15 | V/V                    |
| Maximum Input Signal         | $V_{PIN\ 1} = 5\text{ V}$ <sup>(5)</sup>   | 0.9  | 1    | 1.1  | V                      |
| PSRR                         | $12 \leq V_{CC} \leq 25\text{ V}$ <sup>(2)(5)</sup>                                  |      | 70   |      |                        |
| Input Bias Current           |  |      | -2   | -10  | $\mu\text{A}$          |
| Delay to Output              | $V_{PIN\ 3} = 0\text{ V}$ to $2\text{ V}$ <sup>(2)</sup>                             |      | 150  | 300  |                        |
| <b>OUTPUT SECTION</b>        |  |      |      |      |                        |
| Output Low Level             | $I_{SINK} = 20\text{ mA}$  |      | 0.1  | 0.4  | V                      |
|                              | $I_{SINK} = 200\text{ mA}$   |      | 1.5  | 2.2  |                        |
| Output High Level            | $I_{SOURCE} = 20\text{ mA}$  | 13   | 13.5 |      |                        |
|                              | $I_{SOURCE} = 200\text{ mA}$   | 12   | 13.5 |      |                        |
| Rise Time                    | $T_J = 25^{\circ}\text{C}$ , $C_L = 1\text{ nF}$ <sup>(2)</sup>                      |      | 50   | 150  | ns                     |
| Fall Time                    | $T_J = 25^{\circ}\text{C}$ , $C_L = 1\text{ nF}$ <sup>(2)</sup>                      |      | 50   | 150  |                        |

(1) Adjust  $V_{CC}$  above the start threshold before setting at 15 V.

(2) These parameters, although specified, are not 100% tested in production.

(3) Temperature stability, sometimes referred to as average temperature coefficient, is described by the equation:

$$\text{Temp Stability} = \frac{V_{REF(\text{max})} - V_{REF(\text{min})}}{T_J(\text{max}) - T_J(\text{min})}$$

$V_{REF(\text{max})}$  and  $V_{REF(\text{min})}$  are the maximum and minimum reference voltages measured over the appropriate temperature range. Note that the extremes in voltage do not necessarily occur at the extremes in temperature.

(4) Output frequency equals oscillator frequency.

(5) Parameter measured at trip point of latch with  $V_{PIN\ 2} = 0$ .

(6) Gain defined as:  $A = \frac{\Delta V_{PIN\ 1}}{\Delta V_{PIN\ 3}}$ ,  $0 \leq V_{PIN\ 3} \leq 0.8\text{ V}$

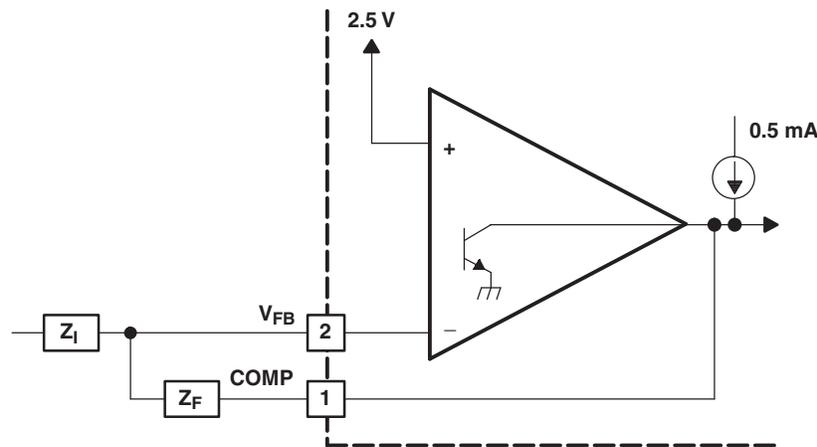
### ELECTRICAL CHARACTERISTICS (continued)

Unless otherwise stated, these specifications apply for  $-55^{\circ}\text{C} \leq T_A \leq 125^{\circ}\text{C}$ ;  $V_{CC} = 15\text{ V}$ ;  $R_T = 10\text{ kW}$ ;  $C_T = 3.3\text{ nF}$ ,  $T_A = T_J$ .

| PARAMETER                            | TEST CONDITIONS                        | MIN | TYP | MAX  | UNIT |
|--------------------------------------|--|-----|-----|------|------|
| <b>UNDER-VOLTAGE LOCKOUT SECTION</b> |  |     |     |      |      |
| Start Threshold                      |  | 7.8 | 8.4 | 9.0  | V    |
| Min. Operating Voltage After Turn On |  | 7.0 | 7.6 | 8.2  |      |
| <b>PWM SECTION</b>                   |  |     |     |      |      |
| Maximum Duty Cycle                   |  | 95% | 97% | 100% |      |
| Minimum Duty Cycle                   |  |     |     | 0%   |      |
| <b>TOTAL STANDBY CURRENT</b>         |  |     |     |      |      |
| Start-Up Current                     |  |     | 0.5 | 1    | mA   |
| Operating Supply Current             | $V_{PIN\ 2} = V_{PIN\ 3} = 0\text{ V}$ |     | 11  | 17   |      |
| $V_{CC}$ Zener Voltager              | $I_{CC} = 25\text{ mA}$                | 30  | 34  |      | V    |

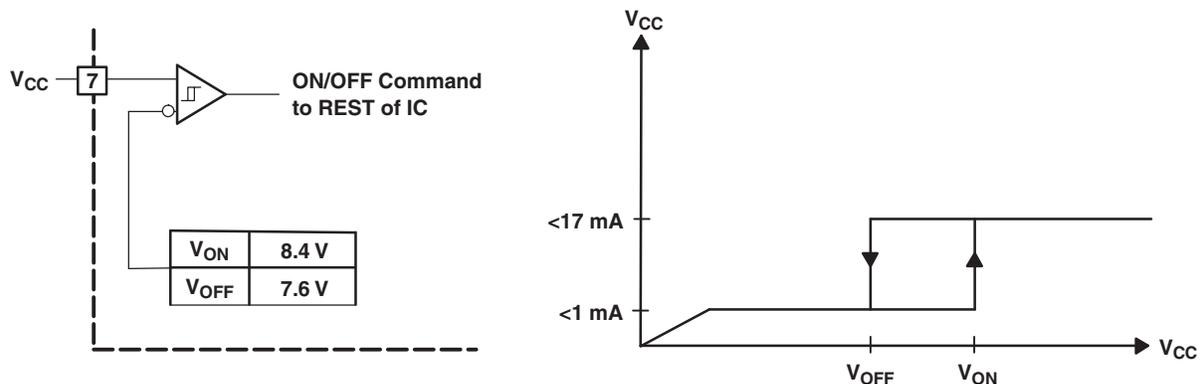
### ERROR AMP CONFIGURATION

Error amp can source or sink up to 0.5 mA.



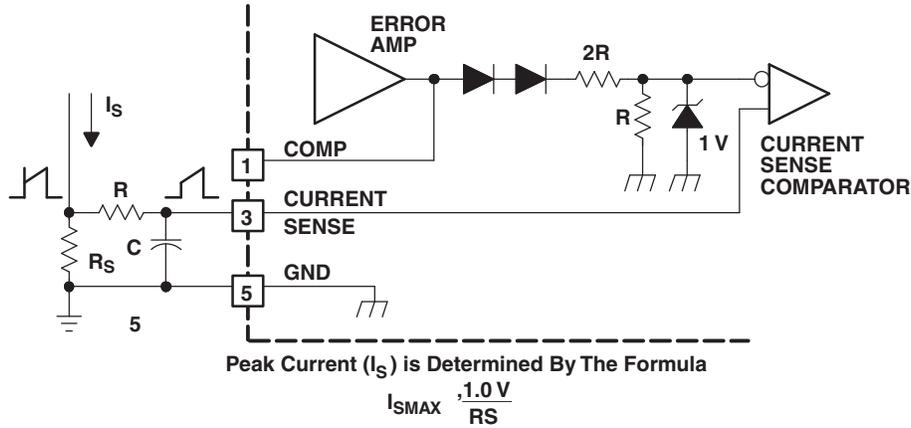
### UNDER-VOLTAGE LOCKOUT

During under-voltage lock-out, the output drive is biased to sink minor amounts of current. Pin 6 should be shunted to ground with a bleeder resistor to prevent activating the power switch with extraneous leakage currents.

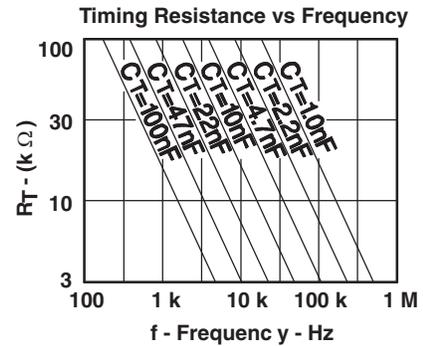
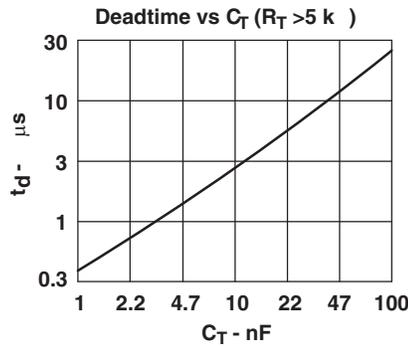
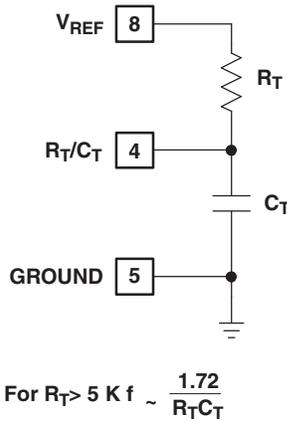


### CURRENT SENSE CIRCUIT

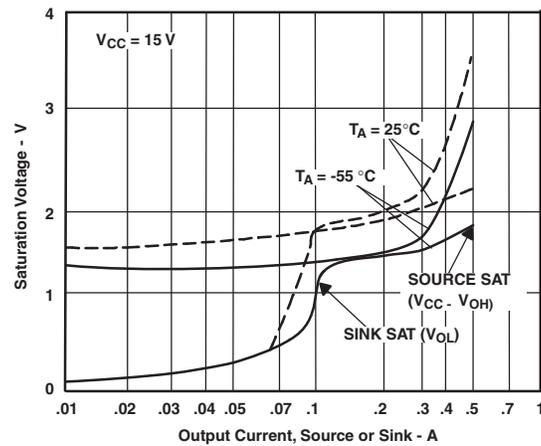
A small RC filter may be required to suppress switch transients.



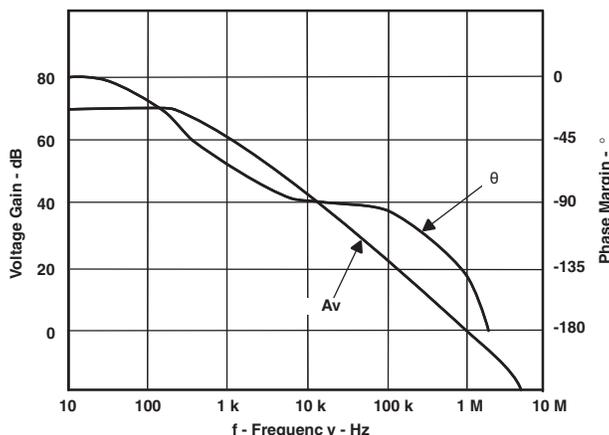
### OSCILLATOR SECTION



### OUTPUT SATURATION CHARACTERISTICS

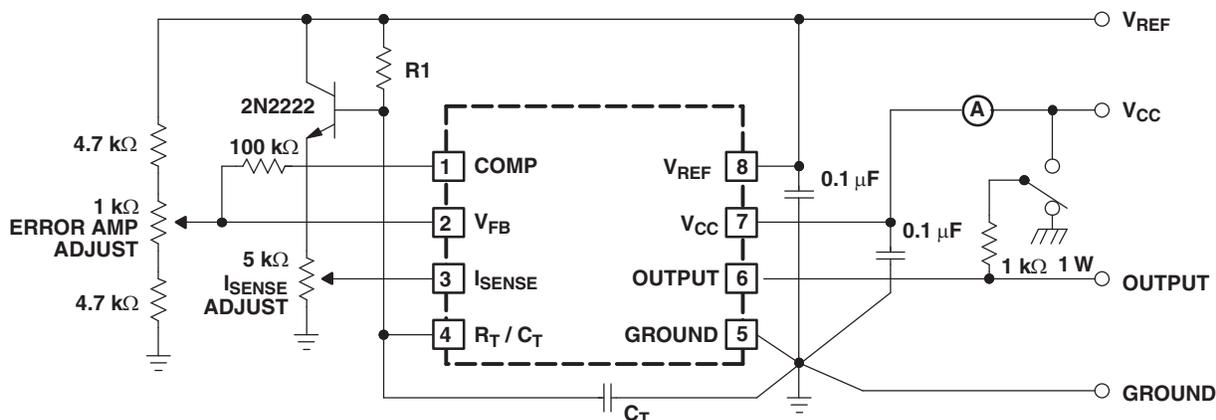


## ERROR AMPLIFIER OPEN-LOOP FREQUENCY RESPONSE



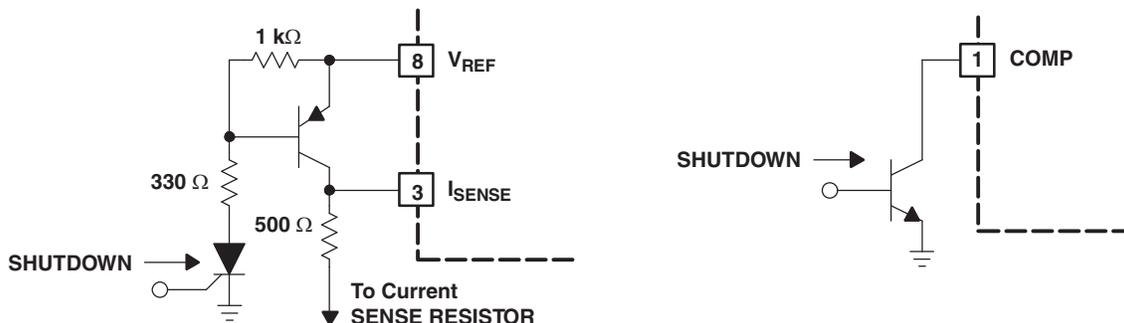
## OPEN-LOOP LABORATORY FIXTURE

High peak currents associated with capacitive loads necessitate careful grounding techniques. Timing and bypass capacitors should be connected close to pin 5 in a single point ground. The transistor and 5k potentiometer are used to sample the oscillator waveform and apply an adjustable ramp to pin 3.

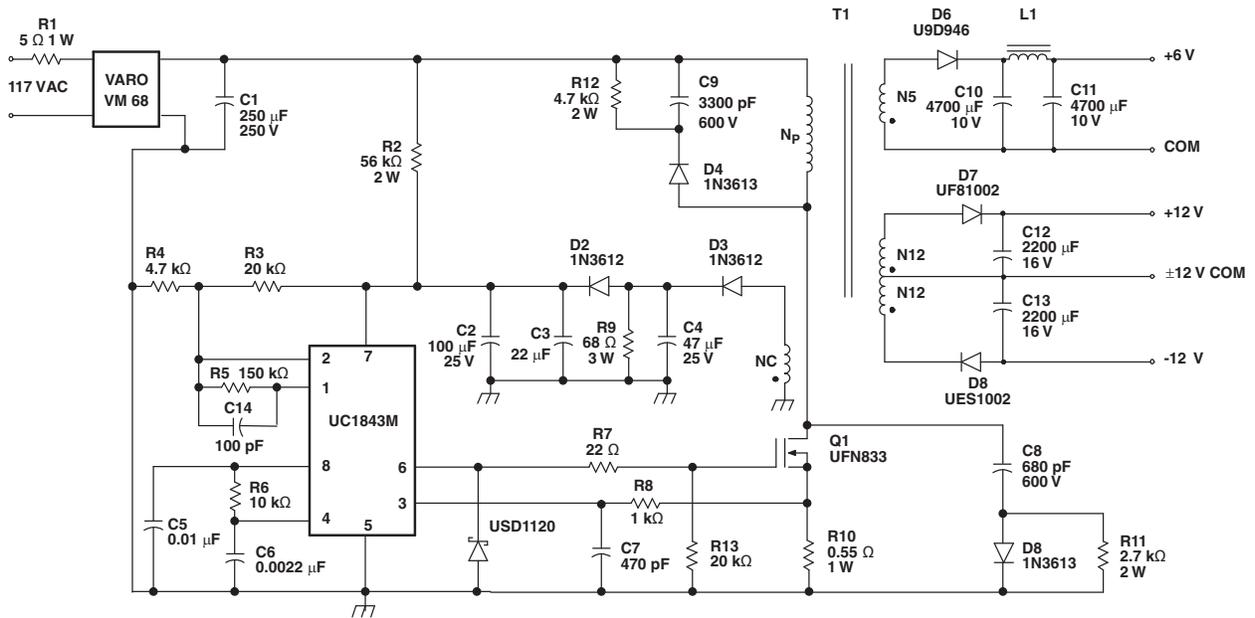


## SHUTDOWN TECHNIQUES

Shutdown of the UC1843 can be accomplished by two methods; either raise pin 3 above 1 V or pull pin 1 below a voltage two diode drops above ground. Either method causes the output of the PWM comparator to be high (refer to block diagram). The PWM latch is reset dominant so that the output will remain low until the next clock cycle after the shutdown condition at pin 1 and/or 3 is removed. In one example, an externally latched shutdown may be accomplished by adding an SCR which will be reset by cycling  $V_{CC}$  below the lower UVLO threshold. At this point the reference turns off, allowing the SCR to reset.



### OFFLINE FLYBACK REGULATOR

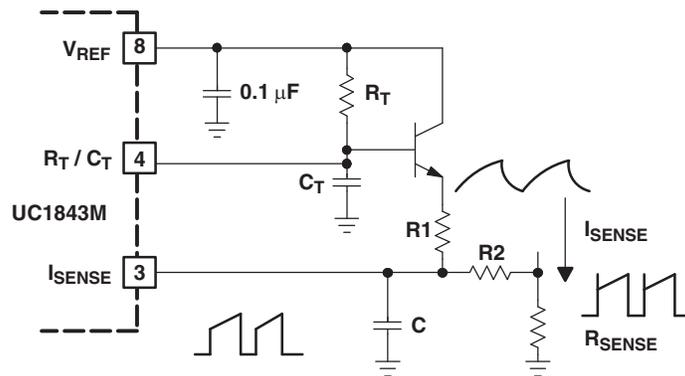


#### Power Supply Specifications

1. Input Voltages
  - a. 5VAC to 130VA (50 Hz/60 Hz)
2. Line Isolation: 3750 V
3. Switchng Frequency: 40 kHz
4. Efficiency at Full Load 70%
5. Output Voltage:
  - a. +5 V,  $\pm 5\%$ ; 1A to 4A load  
Ripple voltage: 50 mV P-P Max
  - b. +12 V,  $\pm 3\%$ ; 0.1A to 0.3A load  
Ripple voltage: 100 mV P-P Max
  - c. -12 V,  $\pm 3\%$ ; 0.1A to 0.3A load  
Ripple voltage: 100 mV P-P Max

#### SLOPE COMPENSATION

A fraction of the oscillator ramp can be resistively summed with the current sense signal to provide slope compensation for converters requiring duty cycles over 50%.



## PACKAGING INFORMATION

| Orderable part number | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-----------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| UC1843MKGD1           | Active        | Production           | XCEPT (KGD)   0 | 100   NOT REQUIRED    | Yes         | Call TI                              | N/A for Pkg Type                  | -55 to 125   |                     |
| UC1843MKGD1.A         | Active        | Production           | XCEPT (KGD)   0 | 100   NOT REQUIRED    | Yes         | Call TI                              | N/A for Pkg Type                  | -55 to 125   |                     |

(1) **Status:** For more details on status, see our [product life cycle](#).

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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### OTHER QUALIFIED VERSIONS OF UC1843-HIREL :

- Space : [UC1843-SP](#)

**NOTE: Qualified Version Definitions:**

- Space - Radiation tolerant, ceramic packaging and qualified for use in Space-based application

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